MOSFET - N-Channel, **SOT-23**

2.8 A, 20 V

These miniature surface mount MOSFETs low RDS(on) assure minimal power loss and conserve energy, making these devices ideal for use in space sensitive power management circuitry.

Features

- Low R_{DS(on)} Provides Higher Efficiency and Extends Battery Life
- Miniature SOT-23 Surface Mount Package Saves Board Space
- I_{DSS} Specified at Elevated Temperature
- AEC Q101 Qualified and PPAP Capable MVSF2N02EL
- These Devices are Pb-Free and are RoHS Compliant

Applications

- DC-DC Converters
- Power Management in Portable and Battery Powered Products, ie: Computers, Printers, PCMCIA Cards, Cellular and Cordless Telephones

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

| Rating | Symbol | Value | Unit |
|---|-----------------------------------|----------------|------|
| Drain-to-Source Voltage | V _{DSS} | 20 | Vdc |
| Gate-to-Source Voltage - Continuous | V _{GS} | ± 8.0 | Vdc |
| Drain Current - Continuous @ T _A = 25°C - Single Pulse (t _p = 10 μs) | I _D I _{DM} | 2.8 5.0 | Α |
| Total Power Dissipation @ T _A = 25°C | P _D | 1.25 | W |
| Operating and Storage Temperature Range | T _J , T _{stg} | – 55 to 150 | °C |
| Thermal Resistance Junction-to-Ambient (Note 1) Thermal Resistance Junction-to-Ambient (Note 2) | $R_{	heta JA}$ | 100 300 | °C/W |
| Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds | TL | 260 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

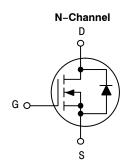
- 1. 1" Pad, t < 10 sec.
- 2. Min pad, steady state.



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2.8 A, 20 V $R_{DS(on)} = 85 \text{ m}\Omega \text{ (max)}$



MARKING DIAGRAM



SOT-23 **CASE 318** STYLE 21



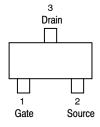
XXX М

= Specific Device Code

= Date Code

= Pb-Free Package

PIN ASSIGNMENT



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Characteristic | | | Min | Тур | Max | Unit |
|--|--|---------------------|-----------|-----------|-----------|--------------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-to-Source Breakdown Voltage (Note 3) (V _{GS} = 0 Vdc, I _D = 10 μAdc) Temperature Coefficient (Positive) | | | 20 - | - 22 | - - | Vdc mV/°C |
| Zero Gate Voltage Drain Current $ (V_{DS} = 20 \text{ Vdc}, V_{GS} = 0 \text{ Vdc}) $ $ (V_{DS} = 20 \text{ Vdc}, V_{GS} = 0 \text{ Vdc}, T_J = 125^{\circ}\text{C}) $ | | | - - | - - | 1.0 10 | μAdc |
| Gate-Source Leakage Current (V _{GS} = ± 8.0 Vdc, V _{DS} = 0 Vdc) | | | _ | - | ±100 | nA |
| ON CHARACTERISTICS (Note 3) | | | | | | |
| Gate–Source Threshold Voltage $(V_{DS} = V_{GS}, I_D = 250 \mu Adc)$ Threshold Temperature Coefficient (Negative) | | | 0.5 - | - -2.3 | 1.0 | Vdc mV/°C |
| Static Drain-to-Source On-Resistan (V_{GS} = 4.5 Vdc, I_D = 3.6 A) (V_{GS} = 2.5 Vdc, I_D = 3.1 A) | R _{DS(on)} | - - | 78 105 | 85 115 | mΩ | |
| DYNAMIC CHARACTERISTICS | | | | | | |
| Input Capacitance | | C _{iss} | _ | 150 | _ | pF |
| Output Capacitance | $(V_{DS} = 5.0 \text{ Vdc}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz})$ | C _{oss} | _ | 130 | - | |
| Transfer Capacitance | , | C _{rss} | - | 45 | - | |
| SWITCHING CHARACTERISTICS (No | ote 4) | | | | | |
| Turn-On Delay Time | | t _{d(on)} | - | 6.0 | - | ns |
| Rise Time | $(V_{DD} = 16 \text{ Vdc}, I_D = 2.8 \text{ Adc},$ | t _r | _ | 95 | - | |
| Turn-Off Delay Time | V_{gs} = 4.5 V, R_{G} = 2.3 Ω) | t _{d(off)} | _ | 28 | - | |
| Fall Time | | t _f | - | 125 | - | |
| Gate Charge | | Q _T | - | 3.5 | - | nC |
| | $(V_{DS} = 16 \text{ Vdc}, I_D = 1.75 \text{ Adc}, V_{GS} = 4.0 \text{ Vdc}) \text{ (Note 3)}$ | Q _{gs} | - | 0.6 | - | |
| | 140 124, (1111 3, | Q _{gd} | = | 1.5 | - | |
| SOURCE-DRAIN DIODE CHARACTE | ERISTICS | | | | | |
| Forward Voltage | (I _S = 1.0 Adc, V _{GS} = 0 Vdc) (Note 3) | V _{SD} | _ _ | 0.76 | 1.2 | ٧ |
| Reverse Recovery Time | | t _{rr} | _ | 104 | - | ns |
| | $(I_S = 1.0 \text{ Adc}, V_{GS} = 0 \text{ Vdc},$ | ta | - | 42 | - | 1 |
| | $dl_{S}/dt = 100 A/\mu s)$ (Note 3) | t _b | _ | 62 | - | |
| Reverse Recovery Stored Charge | | Q _{RR} | _ | 0.20 | - | μC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------------|-----------|-----------------------|
| MGSF2N02ELT1G | SOT-23 | 2 000 / Tong & Book |
| MVSF2N02ELT1G* | (Pb-Free) | 3,000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{3.} Pulse Test: Pulse Width \leq 300 $\mu s,$ Duty Cycle \leq 2%.

^{4.} Switching characteristics are independent of operating junction temperature.

^{*}MVSF Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

TYPICAL CHARACTERISTICS

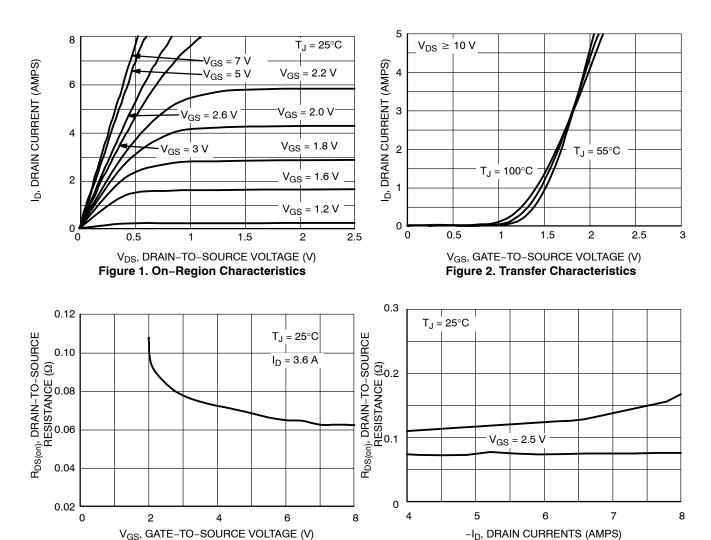
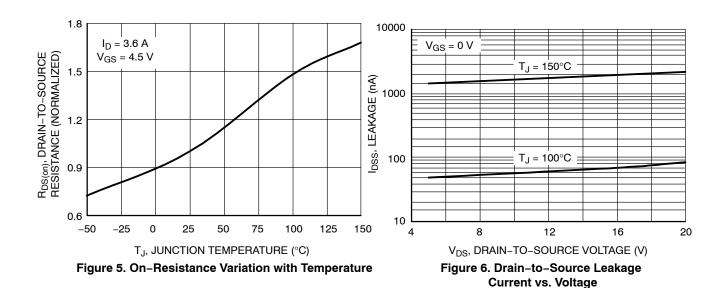


Figure 3. On-Resistance vs. Gate-to-Source Voltage

Figure 4. On-Resistance vs. Gate Voltage



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TYPICAL CHARACTERISTICS

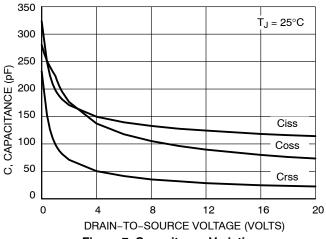
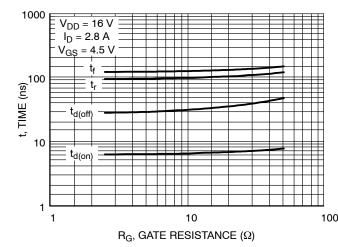


Figure 7. Capacitance Variation

Figure 8. Gate-to-Source Voltage vs. Total Charge



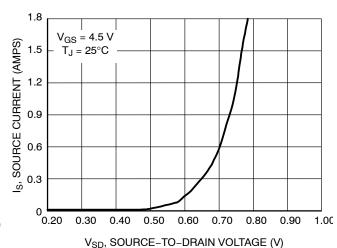
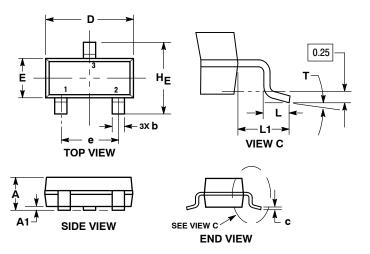


Figure 9. Resistive Switching Time Variation vs.
Gate Resistance

Figure 10. Diode Forward Voltage vs. Current

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AR**



- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

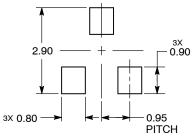
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
 MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
- THE BASE MATERIAL.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH,
 PROTRUSIONS, OR GATE BURRS.

| | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 0.89 | 1.00 | 1.11 | 0.035 | 0.039 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.000 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.017 | 0.020 |
| С | 0.08 | 0.14 | 0.20 | 0.003 | 0.006 | 0.008 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| е | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.080 |
| L | 0.30 | 0.43 | 0.55 | 0.012 | 0.017 | 0.022 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.027 |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |
| Т | 0° | | 10° | 0° | | 10° |

STYLE 21:

- PIN 1. GATE
 - SOURCE 2.
 - DRAIN

RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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